

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT7218318

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MITEK HOLDINGS, INC.	10/01/2021
RECEIVING PARTY DATA		
Name:	HEAT-PIPE TECHNOLOGY, INC.	
Street Address:	6904 PARKE EAST BLVD.	
City:	TAMPA	
State/Country:	FLORIDA	
Postal Code:	33610	
PROPERTY NUMBERS Total: 5		
Property Type	Number	
Application Number:	15952758	
Application Number:	16572309	
Application Number:	17215584	
Patent Number:	10274221	
Patent Number:	10962303	
CORRESPONDENCE DATA		
Fax Number:	(314)863-9388	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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Correspondent Name:	STINSON LLP	
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ATTORNEY DOCKET NUMBER:	MLP 8118	
NAME OF SUBMITTER:	KIM SCHIMWEG	
SIGNATURE:	/Kim Schimweg/	
DATE SIGNED:	03/10/2022	
Total Attachments: 4		
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ASSIGNMENT

1. **WHEREAS**, MITEK HOLDINGS, INC. of Wilmington, Delaware, a corporation duly organized and existing under and by virtue of the laws of the State of Delaware (hereinafter referred to as Assignor), is the owner of the entire right, title, and interest in and to certain letters patent of the United States and the inventions disclosed therein; and to certain applications for letters patent of the United States and outside the United States and the inventions disclosed therein; and

2. **WHEREAS**, HEAT-PIPE TECHNOLOGY, INC. of Tampa, Florida, a corporation duly organized and existing under and by virtue of the laws of the State of Florida (hereinafter referred to as Assignee), is desirous of acquiring said right, title, and interest of Assignor;

3. **NOW, THEREFORE**, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration by Assignee to Assignor in hand paid, receipt of all of which is hereby acknowledged, Assignor has agreed to and does hereby sell, assign and transfer unto Assignee, its successors and assigns, all of Assignor's right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to said letters patent and all reissues thereof and reexamination certificates therefor, and the inventions disclosed therein, including Assignor's full right to sue for and recover all damages recoverable from past infringements of said letters patent; including specifically, without limiting

the generality of the foregoing, the United States patent listed below; and Assignor has further agreed to and does hereby sell, assign and transfer unto Assignee, its successors and assigns, all of Assignor's right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to said inventions, said United States applications, any other United States applications (including provisional, non-provisional, divisional, continuing, or reissue application) based in whole or in part on said United States applications or in whole or in part on said inventions, any foreign applications based in whole or in part on any of the aforesaid United States applications or in whole or in part on said inventions, and any and all patents (including extensions thereof) of any country which have been or may be granted on any of the aforesaid applications or on said inventions or any part thereof; including, specifically, without limiting the generality of the foregoing, the United States application listed below.

4. **TO BE HELD AND ENJOYED BY** Assignee, its successors and assigns, to the full ends of the respective terms full for which said patents have been or may be granted, as fully and entirely as the same would have been held and enjoyed by Assignor had this sale and assignment not been made.

5. **AND** Assignor hereby authorized and requests the Director of the United States Patent and Trademark Office of the United States of America to issue any and all United States patents which may be granted upon said United States patent applications to Assignee, its successors and assigns.

6. **AND** Assignor hereby agrees to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue or other applications for patents of any country, that may be deemed necessary by said Assignee, its successors or assigns fully to secure its interest as aforesaid in and to said inventions or any part thereof, and in and to said several patents or any of them.

7. **AND** Assignor covenants that Assignor has granted no right or license to make, use or sell said inventions to anyone except said Assignee, that prior to the execution of this deed, Assignor's right, title, and interest in said inventions has not been otherwise encumbered, and that Assignor has not executed and will not execute any instrument in conflict herewith.

8. THE FOREIGN PATENT APPLICATIONS ARE AS FOLLOWS:

Patent No.	Filed	Inventor(s)	Title of Invention
CA2990359	December 29, 2017	Marcus D'Arcy, et al.	Heat Exchanger
CA3038613	April 1, 2019	Marcus D'Arcy et al.	Heat Exchanger
CA3073057	February 20, 2020	Marcus D'Arcy, et al.	Heat Exchanger
CA3089787	August 10, 2020	Marcus D'Arcy et al.	Passive Split Heat Recovery Systems
CN202010130025.9	February 28, 2020	Marcus D'Arcy et al.	Heat Exchanger

9. THE US LETTERS PATENT ARE AS FOLLOWS:

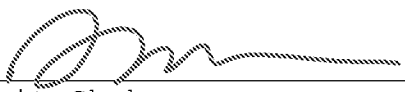
Patent No.	Issued	Inventor(s)	Title of Invention
10,274,221	April 30, 2019	Marcus D'Arcy, et al.	Heat Exchanger
10,962,303	March 30, 2021	Marcus D'Arcy, et al.	Heat Exchanger

10. THE US PATENT APPLICATIONS ARE AS FOLLOWS:

Serial No.	Filed	Inventor(s)	Title of Invention
15/952,758	April 13, 2018	Marcus D'Arcy, et al.	Heat Exchanger
16/572,309	September 16, 2019	Marcus D'Arcy, et al.	Passive Split Heat Recovery System
17/215,584	March 29, 2021	Marcus D'Arcy, et al.	Passive Split Heat Recovery System


11. IN WITNESS WHEREOF, Assignor has caused these presents to be executed by its officers on the date.

For and on behalf of
MiTek Holdings, Inc.


Amit Shah
Senior Vice President, Secretary
& General Counsel

Date 10-01-2021

Accepted on behalf of
Heat-Pipe Technology, Inc.


Amit Shah
Senior Vice President, Secretary &
General Counsel

Date 10-01-2021